FCC ID: W6UHM700L/W6UHM80I85C/W6UHM1900P/W6UHMAWS1 IC ID: 9354A-HM700L/9354A-HM80I85C/9354A-HM1900P/9354A-AWS1

CT Project: p13a0006

From: Daniel Park Date: 2/22/14

FCC & IC

1. Please provide FCC and IC confidentiality letters with own information only. Please don't mix with those two IDs together. Also, please stated only confidential exhibits in the letter.

Solid – Please refer to updated cover letters.

2. Based on EUT configuration, the Rule Part 90.219 warning label should be included. No specific guidance was found from FCC whether 90.219 label can be exempted. Please clarify whether Rule Part 90.219 warning label can be omitted. Otherwise, please provide.

Solid - Please refer to updated labels.

3. Cover Letter for Final Amplification Stage Voltage and Current under rule part 2.1033 (c) (8). Solid – Please refer to block diagram for this information.

4. The "TX composite Power" limit don't agree each other within "user manual" and "Tune up" exhibits, especially, 800 & 850 bands. Please verify.

Solid – Please refer to updated manual and operational description exhibits.

- At the page 9 of RF test report, the title is written as "Uplink" instead. It should be printed as "Downlink". Please correct it.
 CT – Please refer to updated test report.
- 6. Please indicate "KDB 986109" in FCC 731 form for filing the application as well. CT Please note form 731 has this info on page 2.
- 7. Currently, the RF exposure compliance testing report wasn't included in this application. Please clarify whether the RF exposure testing result will be provided to reviewer or RF exposure compliance will be addressed at the time of this device installation. If the RF exposure compliance will be addressed at the time of installation, the grant note must state the condition about RF exposure compliance will be addressed at the time of installation. Please clarify.
 CT Please see MPE reports.

For IC Side:

1. Under RSS-GEN 5.2, supplier should provide the notices and user information in both English and French. Currently, no French has been found. Please provide all the necessary information in French as well.

Solid - Please refer to updated manual.

- 2. RSP-100 section 5.2 b cover letter is missing. Please provide. CT Please refer IC cover letter.
- 3. Currently, IC RF exposure compliance was not clearly documented. Please provide how to comply with IC rule.

CT – Please see IC RSS 102 reports

Response by: SOLID, Inc. & CTL

Submitted by: CTL

Date: 3/5/2014